Features

- 60A Output Current
- Multi-Phase Topology
- +5V Input
- 5-bit Programmable:
  1.3V to 3.5V
  1.075V to 1.850V
- High Efficiency
- Differential Remote Sense
- Short Circuit Protection

- Output Tracking Feature
- Over-Temp Shutdown
- Power Good & OV Flag
- Low-Profile Package
- Solderable Copper Case
- "Current Booster" Compatible

Ordering Information

PT8001❑ = 1.3 to 3.5 Volts
PT8002❑ = 1.075 to 1.850 Volts

PT Series Suffix (PT1234X)

Case/Pin Configuration	
Vertical Through-Hole	**N**
Horizontal Through-Hole	**A**
Horizontal Surface Mount	**C**

For dimensions and PC board layout, see Package Styles 1600, 1610 and 1615

Description

The PT8000 series is a 60 A high-performance, Integrated Switching Regulator (ISR) housed in a single low-profile 44-pin SIP package. Operating from an input voltage of +5V, the PT8000 series offers a state-of-the-art "Plug-in Power" solution for highly-integrated digital systems that demand high power supply currents at low voltages.

The output voltage from these modules is programmable over a preset range via a 5-bit input. The PT8001 may be set from 1.3V to 3.5V, which is compatible with Intel's Pentium Pro® μ-processors. The output voltage of the PT8002 is programmable from 1.075V to 1.85V.
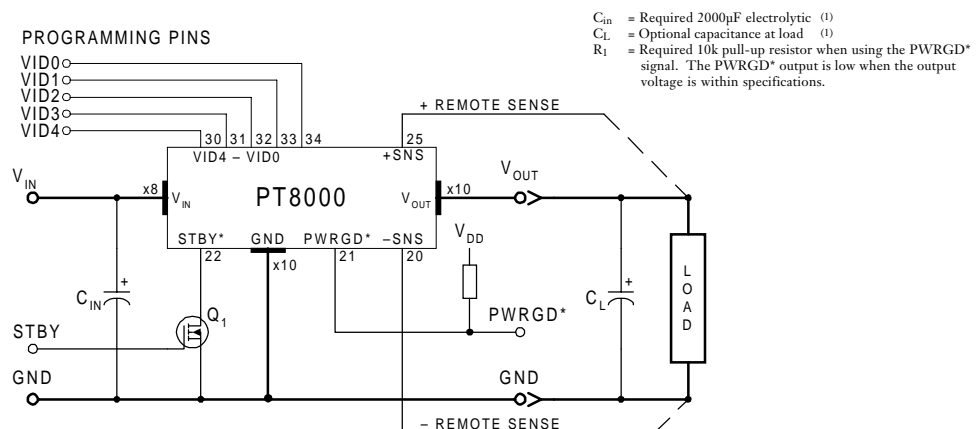
The PT8000 series incorporates many features to facilitate system integration. Output short-circuit protection and over-temperature shutdown enables these modules to survive any load fault. Two self-diagnosotic signals, "Power Good" (PWRGD*) and "Over-Voltage Flag" (OVF*) are provided. And a unique tracking feature allows the output to be synchronized to a master ramp voltage during power-up.

Other features include a standby input, and a differential remote sense to compensate for voltage drop between the ISR and load.

A low ESR capacitance of 2000μF is required at the input for proper operation.

Standard Application

C_{in} = Required 2000μF electrolytic (1)
C_L = Optional capacitance at load (1)
R_1 = Required 10k pull-up resistor when using the PWRGD* signal. The PWRGD* output is low when the output voltage is within specifications.

PT8000—5V

60 Amp High-Performance Programmable ISR

Pin-Out Information

Pin	Function
1	V_out
2	V_in
3	V_in
4	GND
5	GND
6	V_in
7	V_in
8	V_out
9	V_out
10	V_out
11	Synch 1
12	Synch 2
13	Synch 3
14	Synch 4
15	Do Not Connect

Pin	Function
16	GND
17	GND
18	GND
19	V_out
20	Remote Sense Gnd
21	PWRGD*
22	STBY*
23	OVF*
24	Track
25	Remote Sense V_out
26	V_out
27	GND
28	GND
29	GND
30	VID4

Pin	Function
31	VID3
32	VID2
33	VID1
34	VID0
35	V_out
36	V_out
37	V_out
38	V_in
39	V_in
40	GND
41	GND
42	V_in
43	V_in
44	V_out

For STBY* pin; Open = output enabled
Gnd = output disabled.

Programming Information

VID3	VID2	VID1	VID0	PT8001 VID4=1 Vo	PT8001 VID4=0 Vo	PT8002 VID4=1 Vo	PT8002 VID4=0 Vo
1	1	1	1	2.0V	1.30V	1.075V	1.475V
1	1	1	0	2.1V	1.35V	1.100V	1.500V
1	1	0	1	2.2V	1.40V	1.125V	1.525V
1	1	0	0	2.3V	1.45V	1.150V	1.550V
1	0	1	1	2.4V	1.50V	1.175V	1.575V
1	0	1	0	2.5V	1.55V	1.200V	1.600V
1	0	0	1	2.6V	1.60V	1.225V	1.625V
1	0	0	0	2.7V	1.65V	1.250V	1.650V
0	1	1	1	2.8V	1.70V	1.275V	1.675V
0	1	1	0	2.9V	1.75V	1.300V	1.700V
0	1	0	1	3.0V	1.80V	1.325V	1.725V
0	1	0	0	3.1V	1.85V	1.350V	1.750V
0	0	1	1	3.2V	1.90V	1.375V	1.775V
0	0	1	0	3.3V	1.95V	1.400V	1.800V
0	0	0	1	3.4V	2.00V	1.425V	1.825V
0	0	0	0	3.5V	2.05V	1.450V	1.850V

Logic 0 = Pin 20 potential (remote sense gnd)
Logic 1 = Open circuit (no pull-up resistors)
VID3 and VID4 may not be changed while the unit is operating.

Specifications

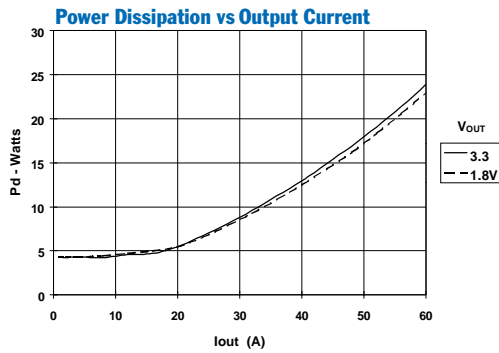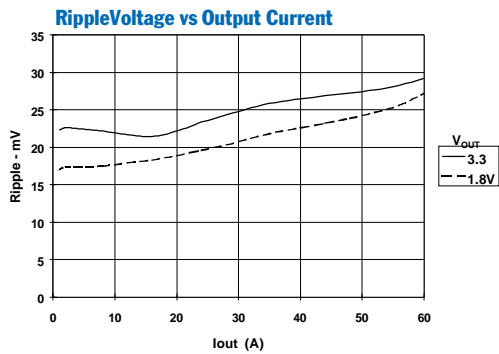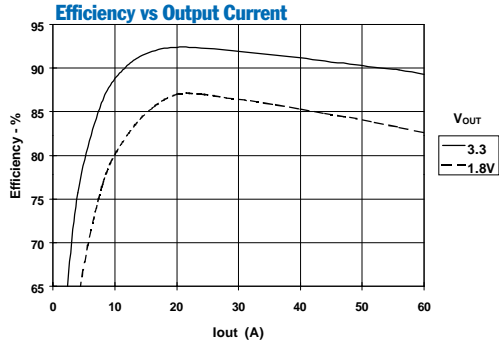| Characteristics (T_a= 25°C unless noted)	Symbols	Conditions	PT8000 SERIES Min	PT8000 SERIES Typ	PT8000 SERIES Max	Units
Output Current	I_o	T_a = +50°C, 400 LFM, pkg N T_a = +25°C, natural convection	0.1 [1] 0.1 [1]	— —	60 [2] 30 [2]	A
Input Voltage Range	V_{in}	$0.1A \leq I_o \leq 60A$	4.5	—	5.5	V
Output Voltage Tolerance	ΔV_o	Over V_{in} range, I_o =I_{omax} $0°C \leq T_a \leq +60°C$	V_o-0.03	—	V_o+0.03	V
Line Regulation	Reg_{line}	Over V_{in} range, I_o = I_{max}	—	±1.0	±10	mV
Load Regulation	Reg_{load}	V_{in} =5V, $0.1 \leq I_o \leq I_{o}max$	—	±1.0	±10	mV
V_o Ripple/Noise pk-pk	V_n	V_{in} =5V, I_o = 60A	—	50	—	mV
Transient Response (no external capacitance)	t_{tr} V_{os}	I_o step from 30A to 60A in 6µs V_o over/undershoot	— —	50 100	— —	µs mV
Efficiency	η	V_{in} = +5V, I_o =30A, V_o =3.3V / V_o =1.8V	— —	92 86	— —	%
Switching Frequency	f_o	Over V_{in} and I_o ranges	1.3	—	1.5	MHz
STBY* (pin 22) Off / On	Off On		0 Note [2]	—	0.8	V
PWRGD* (pin 21) On / Off	On Off	85% <V_{out} <115% of VID set point V_{out} <85%, or V_{out} >125% of VID set point	— —	500 500	— —	Ω kΩ
OVF* (pin 23) On / Off	On Off	Vout > 125% of VID set point Vout < 115% of VID set point	— —	500 500	— —	Ω kΩ
Over-temperature Shutdown Point	OTP	Case temperature -Auto reset	—	105	—	°C
Absolute Maximum Operating Temperature Range	T_a	—	–40	—	+85 [3]	°C
Storage Temperature	T_s	—	-40	—	+125	°C
Weight	—	Vertical/Horizontal	—	110	—	grams

Notes: (1) The ISR will operate down to no load with reduced specifications.

(2) Specified as "Open-Circuit." Either an "open-collector" bipolar transistor, or "open-drain" MOSFET is recommended for controlling this input.

(3) See Safe Operating Area curves or contact the factory to determine the appropriate derating.

Input Filter: To facilitate the high output fast trqansient performance, a high quality 2,000µF input capacitor(s) is required for the PT8000 series. Use either tantalum or Oscon® type capacitors with a maximum ESR (equivalent series resistance) of 20mΩ.

Performance Characteristics, V$_{in}$ =5.0V   (See Note A)

Efficiency vs Output Current

Efficiency - %

Iout (A)

V$_{OUT}$
— 3.3
--- 1.8V

RippleVoltage vs Output Current

Ripple - mV

Iout (A)

V$_{OUT}$
— 3.3
--- 1.8V

Power Dissipation vs Output Current

Pd - Watts

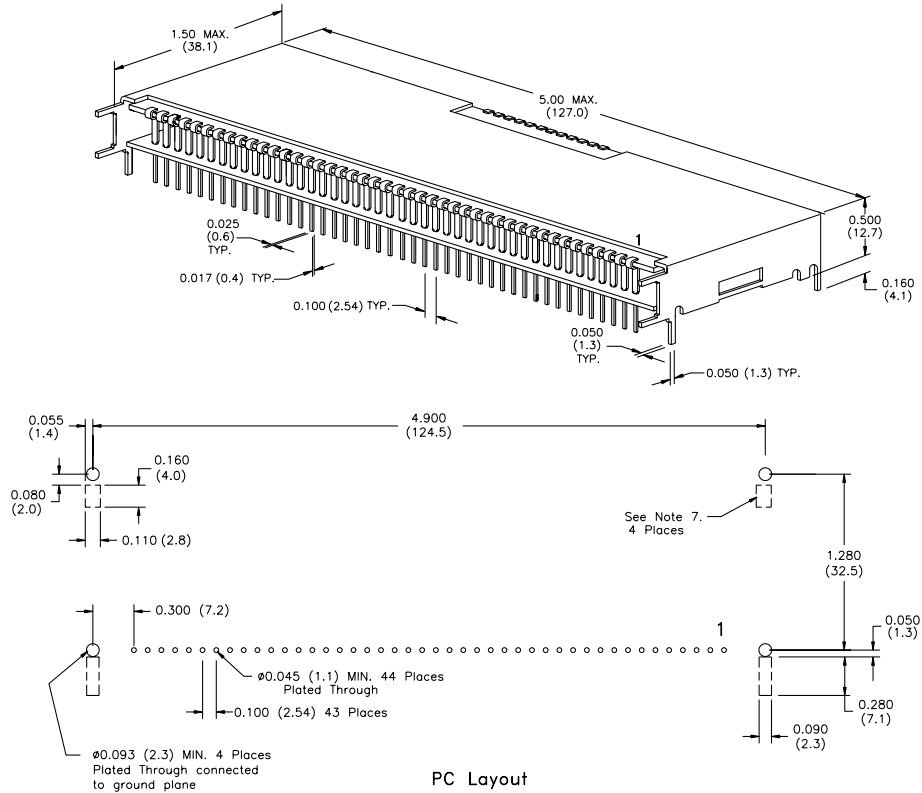Iout (A)

V$_{OUT}$
— 3.3
--- 1.8V

Note A: *Characteristic data has been developed from actual products tested at 25°C. This data is considered typical for the regulator.*
Note B: *Safe Operating Area curves represent conditions at which internal components are at or beow manufacturer's rated operating temperatures.*

TEXAS INSTRUMENTS

PACKAGE INFORMATION AND DIMENSIONS

Vertical Through–Hole Mount (Suffix N)

0.500
(12.7)

5.00 MAX.
(127.0)

0.050
(1.3)
TYP.

0.050
(1.3)
TYP.

1

0.025 (0.6) TYP.

0.017 (0.4) TYP.

0.100 (2.54) TYP.

1.50 MAX.
(38.1)

0.16
(4.1)

0.66
(16.8)

5.00
(127.0)

4.900
(124.5)

See Note 4.

0.050
(1.3)

0.110
(2.8)

0.70
(17.8)

0.350   0.54
(8.9)   (13.7)

1

0.040
(1.0)

0.300 (7.2)

Ø0.045 (1.1) MIN. 44 Places
Plated Through

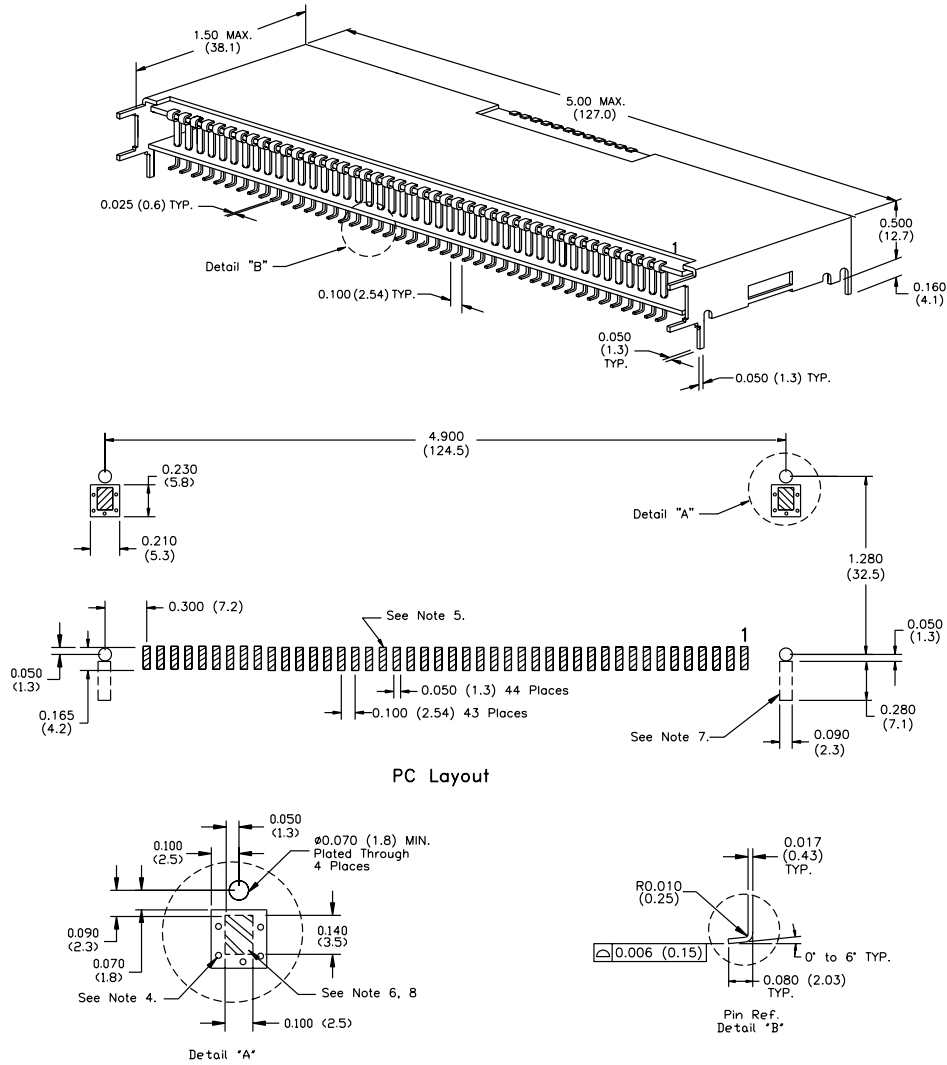0.100 (2.54) 43 Places

0.090 (2.3)
2 Places

Ø0.093 (2.4) 4 Places
Plated Through

PC Layout

Notes: (Rev. A)
1: All dimensions are in inches (mm).
2: 2 place decimals are ±.030 (±0.8mm).
3: 3 place decimals are ±.010 (±0.3mm).
4: Recommended mechanical keep out area (dotted line).

**Power Trends proprietary package design.
All rights reserved. Patent pending.**

TEXAS INSTRUMENTS

PACKAGE INFORMATION AND DIMENSIONS

Horizontal Through—Hole Mount (Suffix A)

1.50 MAX.
(38.1)

5.00 MAX.
(127.0)

0.025
(0.6)
TYP.

0.017 (0.4) TYP.

0.100 (2.54) TYP.

0.500
(12.7)

0.160
(4.1)

0.050
(1.3)
TYP.

0.050 (1.3) TYP.

0.055
(1.4)

0.160
(4.0)

0.080
(2.0)

0.110 (2.8)

4.900
(124.5)

See Note 7.
4 Places

1.280
(32.5)

0.300 (7.2)

Ø0.045 (1.1) MIN. 44 Places
Plated Through

0.100 (2.54) 43 Places

Ø0.093 (2.3) MIN. 4 Places
Plated Through connected
to ground plane

0.050
(1.3)

0.280
(7.1)

0.090
(2.3)

PC Layout

Notes: (Rev. A)
1: All dimensions are in inches (mm).
2: 2 place decimals are ±.030 (±0.8mm).
3: 3 place decimals are ±.010 (±0.3mm).
4: Recommended mechanical keep out area (dotted lines).

Power Trends proprietary package design.
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PACKAGE INFORMATION AND DIMENSIONS

Horizontal Surface Mount (Suffix C)

1.50 MAX.
(38.1)

5.00 MAX.
(127.0)

0.025 (0.6) TYP.

Detail "B"

0.100 (2.54) TYP.

0.500
(12.7)

0.160
(4.1)

0.050
(1.3)
TYP.

0.050 (1.3) TYP.

1

4.900
(124.5)

0.230
(5.8)

0.210
(5.3)

Detail "A"

1.280
(32.5)

0.300 (7.2)

See Note 5.

0.050
(1.3)

0.050
(1.3)

0.165
(4.2)

0.050 (1.3) 44 Places

0.100 (2.54) 43 Places

See Note 7.

0.090
(2.3)

0.280
(7.1)

1

PC Layout

0.050
(1.3)

0.100
(2.5)

ø0.070 (1.8) MIN.
Plated Through
4 Places

0.090
(2.3)

0.070
(1.8)

0.140
(3.5)

See Note 4.

See Note 6, 8

0.100 (2.5)

Detail "A"

0.017
(0.43)
TYP.

R0.010
(0.25)

0.006 (0.15)

0° to 6° TYP.

0.080 (2.03)
TYP.

Pin Ref.
Detail "B"

Notes: (Rev. B)
1: All dimensions are in inches (mm).
2: 2 place decimals are ±.030 (±0.8mm).
3: 3 place decimals are ±.010 (±0.3mm).
4: Vias are recommended to improve copper adhesion.
5: Power pin connections should utilize two or more
   vias per input, ground and output pin.
6: Solder mask openings to copper island for solder
   joints to mechanical pins.
7: Recommended mechanical keep out area (dotted lines).
8: Electrically connected case to ground plane.

**Power Trends proprietary package design.
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TEXAS INSTRUMENTS

PACKAGE OPTION ADDENDUM

PACKAGING INFORMATION

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
PT8002A	NRND	SIP MODULE	ERA	44		TBD	Call TI	Call TI
PT8002C	NRND	SIP MODULE	ERC	44		TBD	Call TI	Call TI
PT8002N	NRND	SIP MODULE	ERD	44		TBD	Call TI	Call TI

[1] The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[2] Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

[3] MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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